

## STN3PF06

P-channel 60 V - 0.20 Ω - 2.5 A - SOT-223 STripFET™ II Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STN3PF06	60 V	< 0.22 Ω	2.5 A

- Extremely dv/dt capability
- 100% avalanche tested
- Application oriented characterization

### **Application**

■ Switching applications

#### **Description**

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

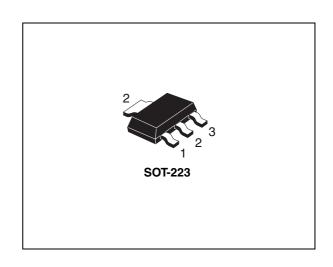


Figure 1. Internal schematic diagram

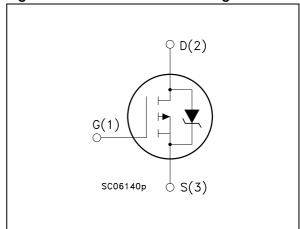


Table 1. Device summary

Order code	Marking	Package	Packaging	
STN3PF06	N3PF06	SOT-223	Tape and reel	

Contents STN3PF06

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STN3PF06 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
$V_{DS}$	Drain-source voltage (V <sub>GS</sub> = 0)	60	V	
V <sub>GS</sub>	Gate-source voltage	±20	٧	
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	2.5	Α	
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	1.5	Α	
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	10	Α	
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	2.5	W	
	Derating factor	0.02	W/°C	
dv/dt (2)	Peak diode recovery voltage slope	6	V/ns	
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature -65 to 150			

<sup>1.</sup> Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub>	Thermal resistance junction-pcb board max	50	°C/W
R <sub>thj-a</sub>	Thermal resistance junction-ambient max <sup>(1)</sup>	62.5	°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	260	°C

<sup>1.</sup> Surface mounted

Note: For the p-channel Power MOSFET actual polarity of voltages and current has to be reversed

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<sup>2.</sup>  $I_{SD} \leq 3A$ , di/dt  $\leq$  200 A/ $\mu$ s,  $V_{DD}$  = 80%  $V_{(BR)DSS}$ 

Electrical characteristics STN3PF06

# 2 Electrical characteristics

(T<sub>CASE</sub>=25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	60			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating $V_{DS}$ = Max rating, $T_{C}$ =125 °C			1 10	μA μA
I <sub>D(on)</sub>	On state drain current	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $V_{GS} = 10 \text{ V}$	2.5			Α
I <sub>GSS</sub>	Gate-body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	٧
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.5 A		0.20	0.22	Ω

Table 5. Dynamic

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 <sub>fs</sub>	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max},$ $I_{D} = 1.25 \text{ A}$		1.5		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$		850 230 75		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	I <sub>D</sub> = 12 A, V <sub>DD</sub> = 48 V, V <sub>GS</sub> = 10 V (see Figure 14)		16 4 6	21	nC nC nC

Note: For the p-channel Power MOSFET actual polarity of voltages and current has to be reversed

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Rise time	$V_{DD}$ = 30 V, $I_{D}$ =6 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10 V (see Figure 13)		20 40		ns ns
t <sub>d(off)</sub>	Turn-off delay time Fall time	$V_{DD}$ = 30 V, $I_{D}$ =6 A, $R_{G}$ =4.7 $\Omega$ , $V_{GS}$ =10 V (see Figure 13)		40 10		ns ns
t <sub>r(Voff)</sub> t <sub>f</sub> t <sub>C</sub>	Off-voltage rise time Fall time Cross-over time	$V_{clamp}$ = 48 V, $I_D$ =12 A, $R_G$ =4.7 $\Omega$ , $V_{GS}$ =10 V (see Figure 13)		10 17 30		ns ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)				2.5 10	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 1.5 A, V <sub>GS</sub> = 0			1.2	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 12 \text{ A, di/dt} = 100 \text{ A/µs}$ $V_{DD} = 30 \text{ V, T}_j = 150 \text{ °C}$		100 260 5.2		ns μC Α

<sup>1.</sup> Pulse width limited by Tjmax

Note: For the p-channel Power MOSFET actual polarity of voltages and current has to be reversed

<sup>2.</sup> Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

Electrical characteristics STN3PF06

### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

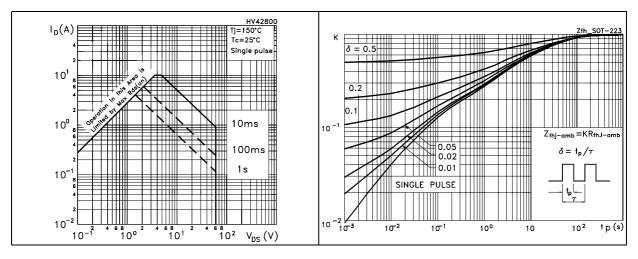


Figure 4. Output characteristics

Figure 5. Transfer characteristics

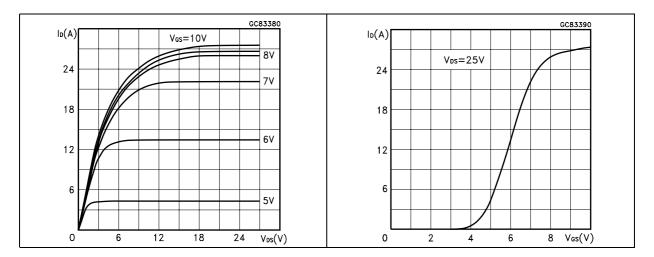
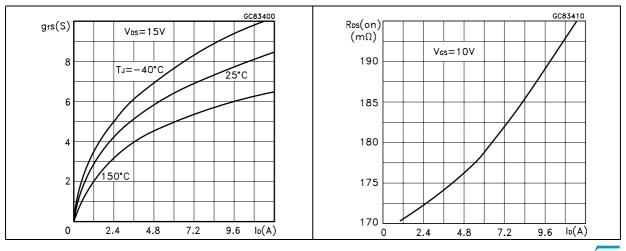


Figure 6. Transconductance

Figure 7. Static drain-source on resistance



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 $V_{DS}(V)$ 

GC83420 GC83430  $V_{GS}(V)$ C(pF) Ciss V<sub>DS</sub>=-48V ID=-12A 800 -1.4f=1MHz600 -4.2  $V_{GS} = 0V$ 400 Coss -9.8200 -12.6Q<sub>g</sub>(nC)

0

10

20

Gate charge vs gate-source voltage Figure 9. Figure 8. **Capacitance variations** 

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

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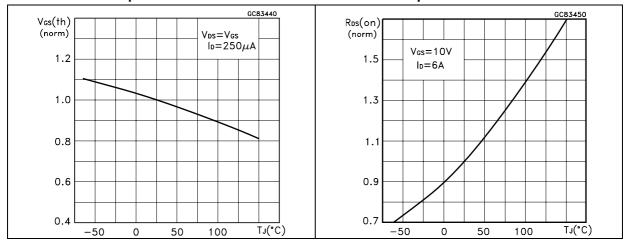
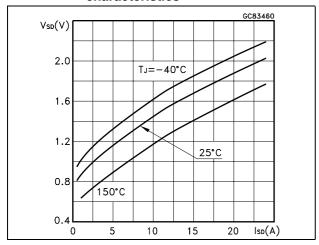


Figure 12. Source-drain diode forward characteristics

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Test circuits STN3PF06

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

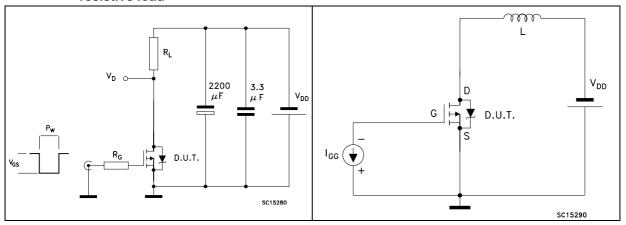
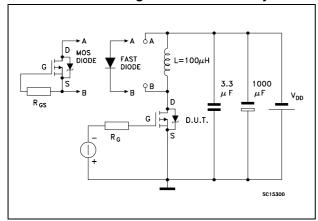


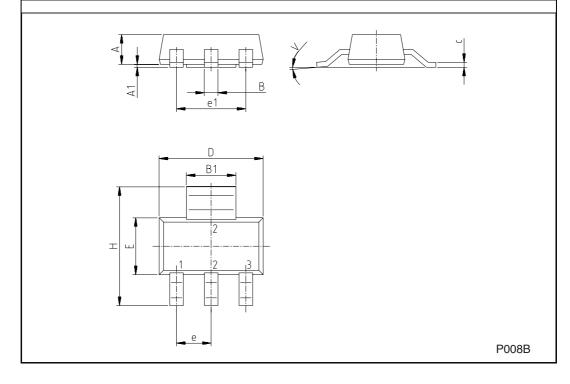
Figure 15. Test circuit for inductive load switching and diode recovery times



# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: <a href="https://www.st.com">www.st.com</a>

	SOT-223 MECHANICAL DATA					
DIM.		mm			inch	
2	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А			1.80			0.071
В	0.60	0.70	0.80	0.024	0.027	0.031
B1	2.90	3.00	3.10	0.114	0.118	0.122
С	0.24	0.26	0.32	0.009	0.010	0.013
D	6.30	6.50	6.70	0.248 0.256		0.264
е		2.30			0.090	
e1		4.60			0.181	
E	3.30	3.50	3.70	0.130	0.138	0.146
Н	6.70	7.00	7.30	0.264	0.276	0.287
V			10°			10°
A1		0.02				



STN3PF06 Revision history

# 5 Revision history

Table 8. Document revision history

Date	Revision	Changes
08-May-2007	3	The document has been reformatted
27-Mar-2008	4	Document status promoted from preliminary data to datasheet.

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